

**USG10R800H**

Preliminary

Power MOSFET

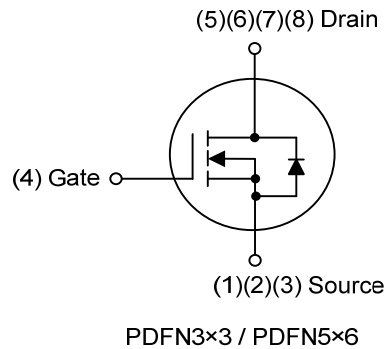
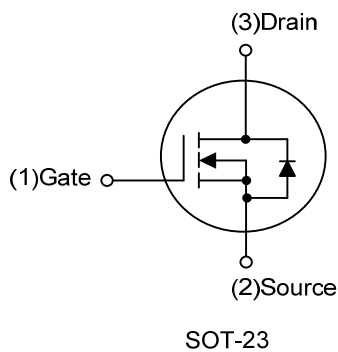
**N-CHANNEL SGT
ENHANCEMENT POWER
MOSFET****DESCRIPTION**

The UTC **USG10R800H** is a N-channel Power MOSFET, it uses UTC's advanced technology to provide the customers with high switching speed and low gate charge, etc.

The UTC **USG10R800H** applies to primary side switch, synchronous rectifier, Motor Drives, etc.

FEATURES

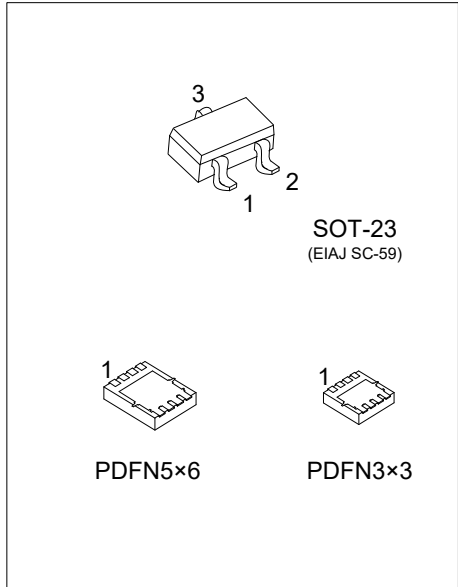
- * $R_{DS(ON)} \leq 80 \text{ m}\Omega$ @ $V_{GS}=10\text{V}$, $I_D=6.0\text{A}$
- * High Cell Density Trench Technology
- * High Power and Current Handling Capability

SYMBOL**ORDERING INFORMATION**

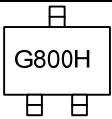
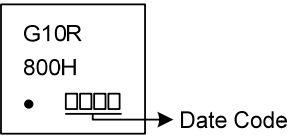
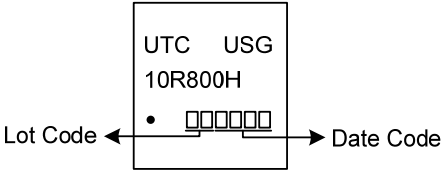
Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
USG10R800HL-AE3-R	USG10R800HG-AE3-R	SOT-23	G	S	D	-	-	-	-	-	Tape Reel
USG10R800HL-P3030-R	USG10R800HG-P3030-R	PDFN3x3	S	S	S	G	D	D	D	D	Tape Reel
USG10R800HL-P5060-R	USG10R800HG-P5060-R	PDFN5x6	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: S: Source G: Gate D: Drain

USG10R800HG-AE3-R		(1)Packing Type	(1) R: Tape Reel
		(2)Package Type	(2) AE3: SOT-23, P3030: PDFN3x3 P5060: PDFN5x6
		(3)Green Package	(3) G: Halogen Free and Lead Free, L: Lead Free



■ MARKING

PACKAGE	MARKING
SOT-23	
PDFN3×3	
PDFN5×6	

■ **ABSOLUTE MAXIMUM RATINGS** ($T_C=25^{\circ}\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DS}	100	V
Gate-Source Voltage		V_{GS}	± 20	V
Drain Current	Continuous	I_D	12	A
	Pulsed (Note 2)	I_{DM}	24	A
Single Pulsed Avalanche Energy (Note 3)		E_{AS}	0.2	mJ
Power Dissipation	SOT-23	P_D	0.5	W
	PDFN3×3		6.7	W
	PDFN5×6		18	W
Junction Temperature		T_J	+150	$^{\circ}\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^{\circ}\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$.

3. $L = 0.1\text{mH}$, $I_{AS} = 2.1\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\Omega$, Starting $T_J = 25^{\circ}\text{C}$

■ **THERMAL DATA**

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	SOT-23	θ_{JA}	416	$^{\circ}\text{C/W}$
	PDFN3×3		130	$^{\circ}\text{C/W}$
	PDFN5×6		65	$^{\circ}\text{C/W}$
Junction to Case	SOT-23	θ_{JC}	250	$^{\circ}\text{C/W}$
	PDFN3×3		18.6	$^{\circ}\text{C/W}$
	PDFN5×6		6.9	$^{\circ}\text{C/W}$

Note: Device mounted on FR-4 substrate P_c board, 2oz copper, with 1inch square copper plate.

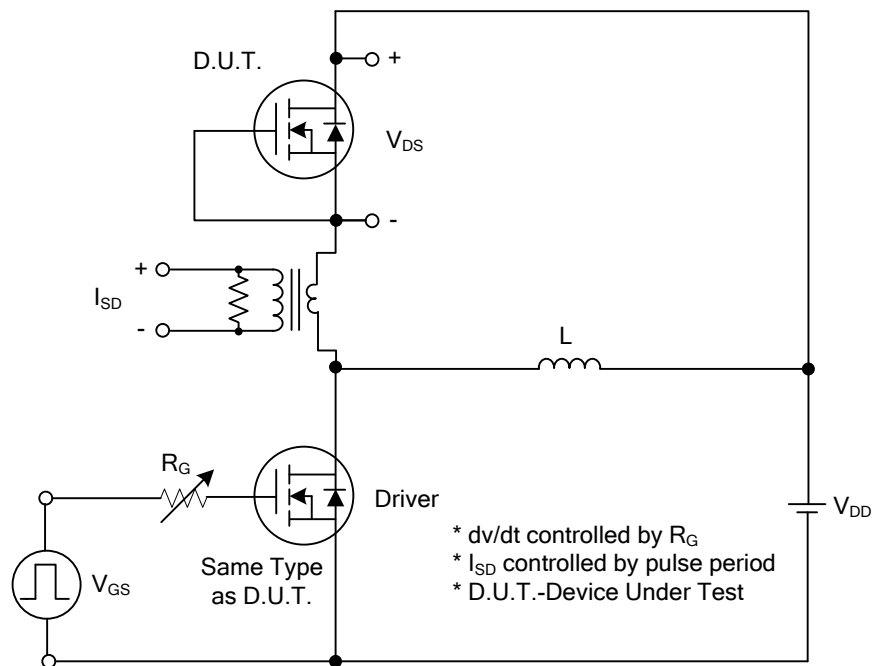
■ **ELECTRICAL CHARACTERISTICS** ($T_J=25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μA, V _{GS} =0V	100			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =100V, V _{GS} =0V			1	μA
Gate-Source Leakage Current	Forward	I _{GSS}	V _{GS} =+20V, V _{DS} =0V			+100	nA
	Reverse		V _{GS} =-20V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250μA	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =6.0A			80	mΩ
DYNAMIC PARAMETERS							
Input Capacitance		C _{ISS}	V _{DS} =25V, V _{GS} =0V, f=1.0MHz		217		pF
Output Capacitance		C _{OSS}			130		pF
Reverse Transfer Capacitance		C _{RSS}			18		pF
SWITCHING PARAMETERS							
Total Gate Charge		Q _G	V _{DS} =80V, V _{GS} =10V, I _D =6.0A		11		nC
Gate to Source Charge		Q _{GS}			3		nC
Gate to Drain Charge		Q _{GD}			2		nC
Turn-ON Delay Time		t _{D(ON)}	V _{DD} =50V, V _{GS} =10V, I _D =6.0A, R _G =3Ω		3		ns
Rise Time		t _R			18		ns
Turn-OFF Delay Time		t _{D(OFF)}			14		ns
Fall-Time		t _F			19		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I _S				12	A
Maximum Body-Diode Pulsed Current		I _{SM}				24	A
Drain-Source Diode Forward Voltage		V _{SD}	I _{SD} =12A			1.4	V

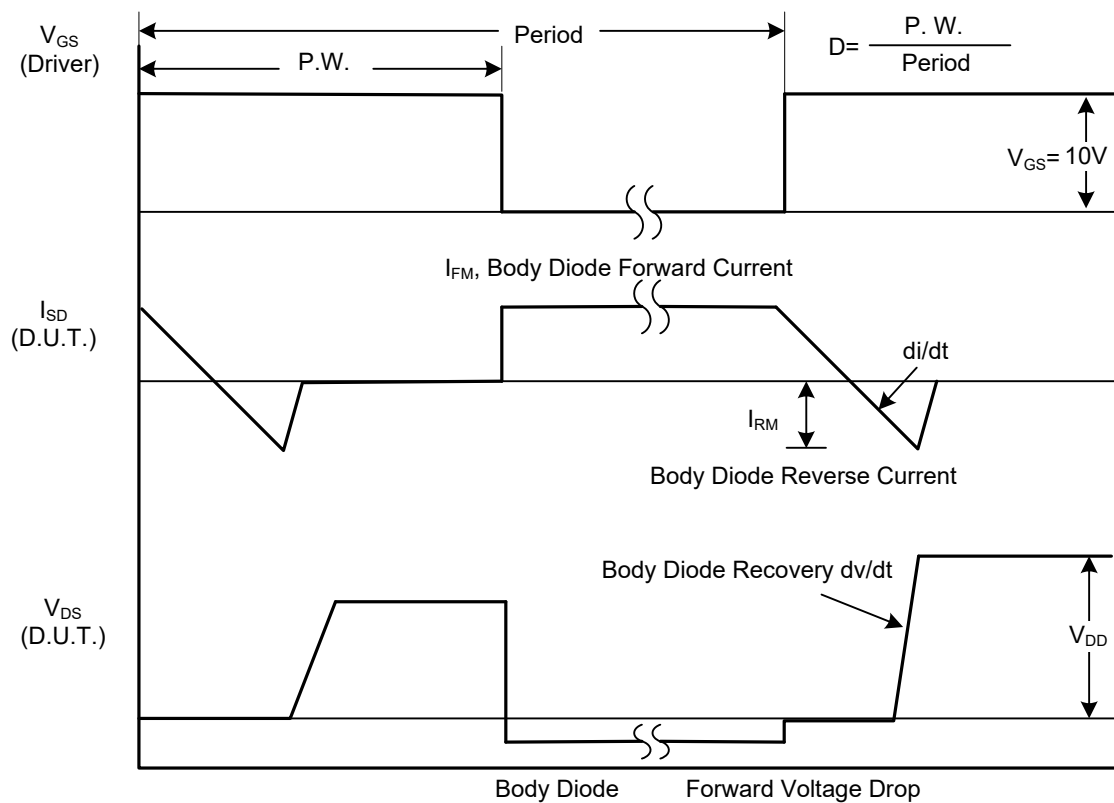
Notes: 1. Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

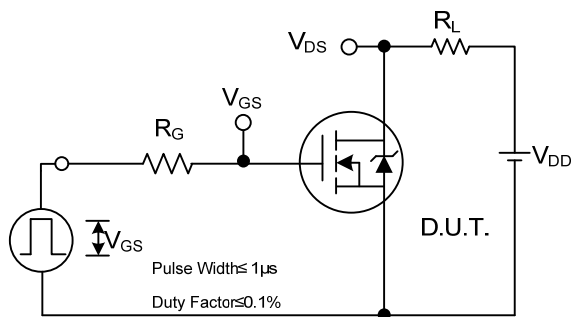


Peak Diode Recovery dv/dt Test Circuit

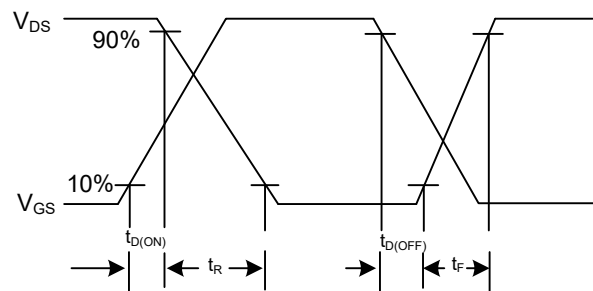


Peak Diode Recovery dv/dt Waveforms

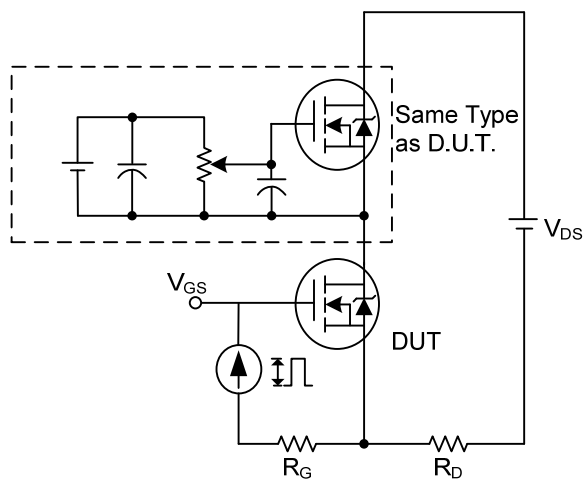
■ TEST CIRCUITS AND WAVEFORMS



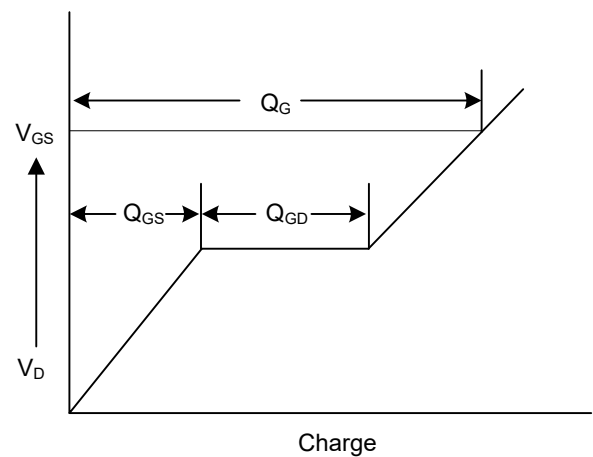
Switching Test Circuit



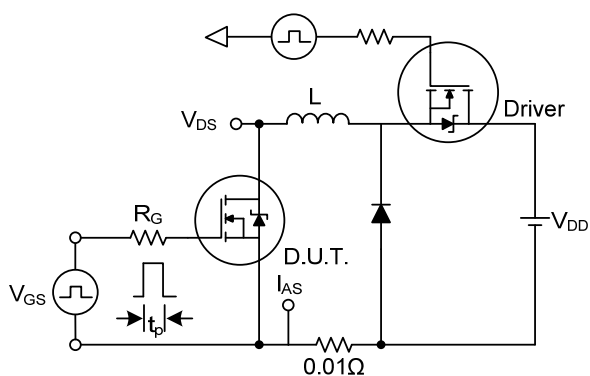
Switching Waveforms



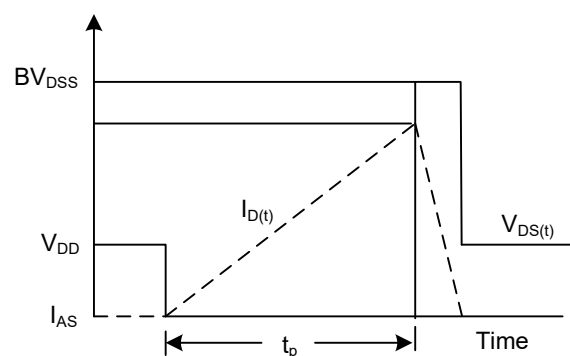
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. UTC reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.